

Anisotropic Substrates Variance for *IBIS-AMI Simulation*



Fluid Dynamics

Structural Mechanics

Electromagnetics

Systems and Multiphysics

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High speed Challenges Today

- (1) High Speed Data Rate Issue**
- (2) Anisotropic Substrates Variance**
- (3) FEM solution to analysis Anisotropic Substrates Variance**
- (4) Anisotropic Substrates Variance for IBIS-AMI Simulation**
- (5) DOE Solution**

High speed IO Challenges Today

As serial links become faster and more complex, it is ever more challenging to model the silicon in an accurate and efficient manner.

Models/Simulator need to handle current challenges:

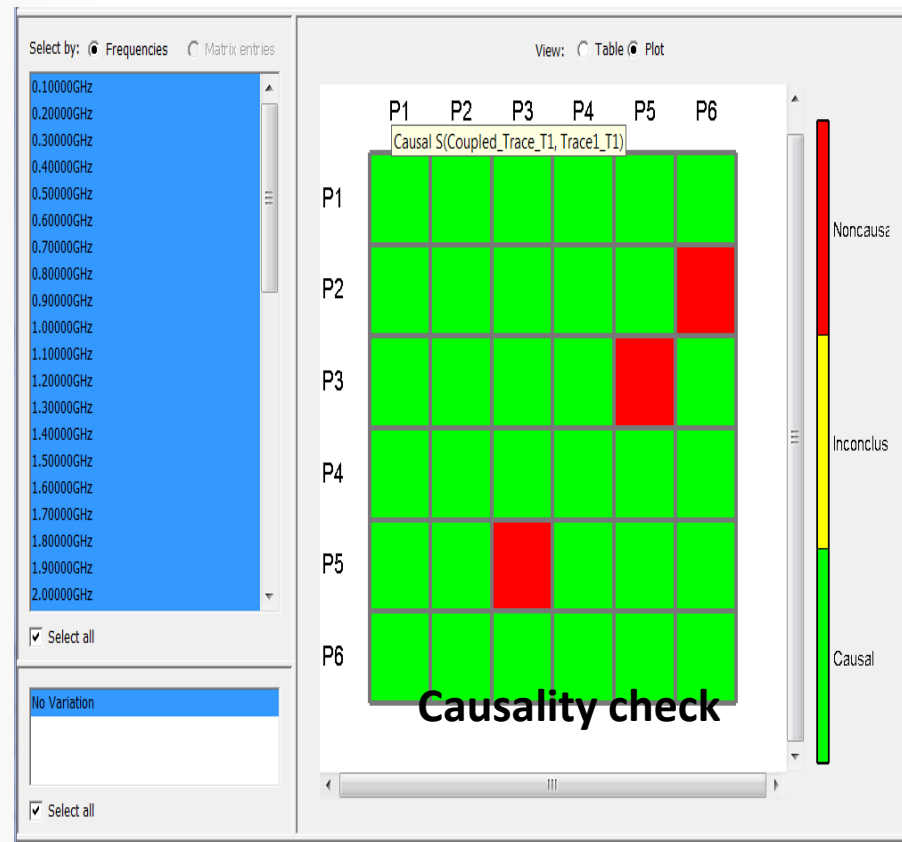
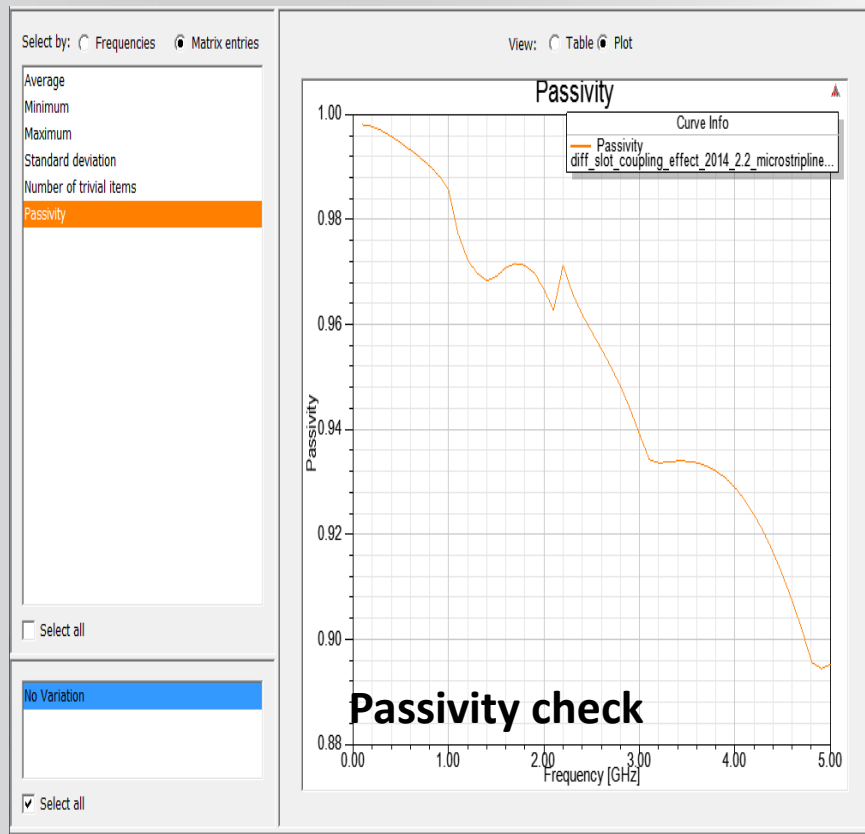
- **Need to accurately handle very high data rates**
- **Simulate large number of bits to achieve low BER**
- **Non-linear, Time Variant Systems**
- **TX/RX equalization**
- **Specific Data patterns and coding schemes**
- **Non-convergence due to unstable models**
- **Channel Issue**

Passivity and Causality

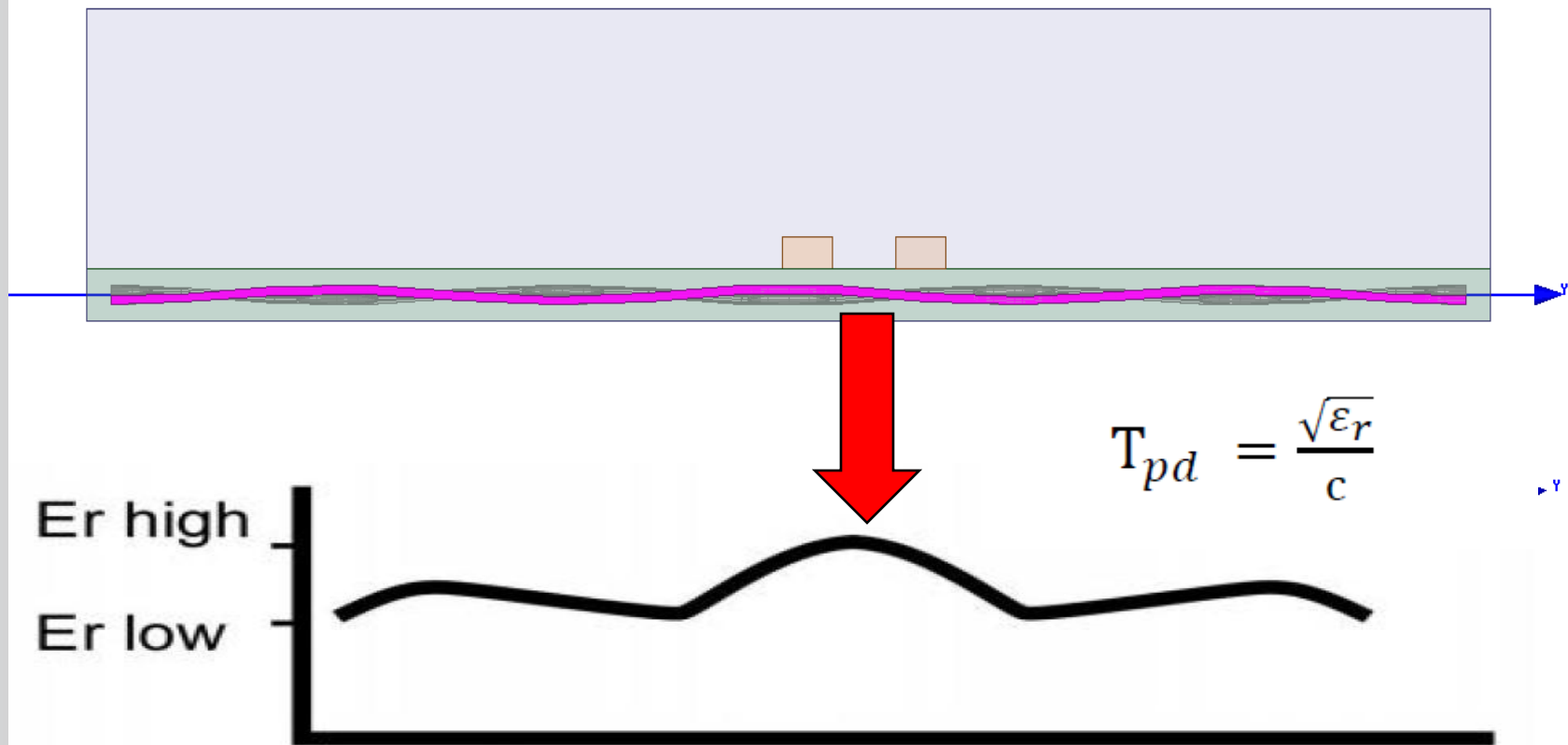
- Though S-parameters from a physics-based extraction tool should always be passive and causal, measured S-parameters often exhibit problems due to noise
- State-space model for S-parameter data guarantees causality of the circuit simulator model
- Two passivity enforcement algorithms
 - Convex programming
 - Perturbation

Check and Enforce Function

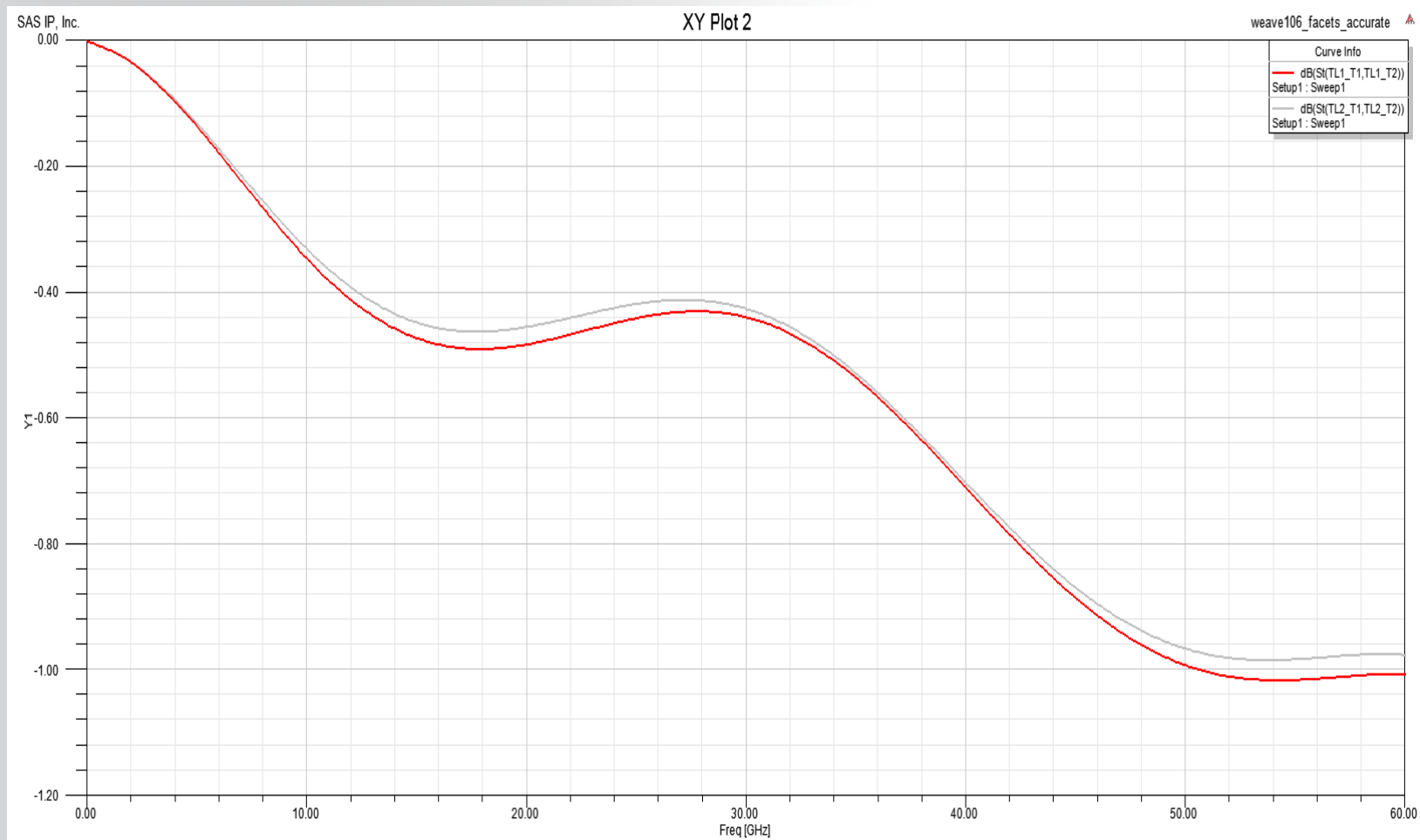
Check and Enforce passivity and causality



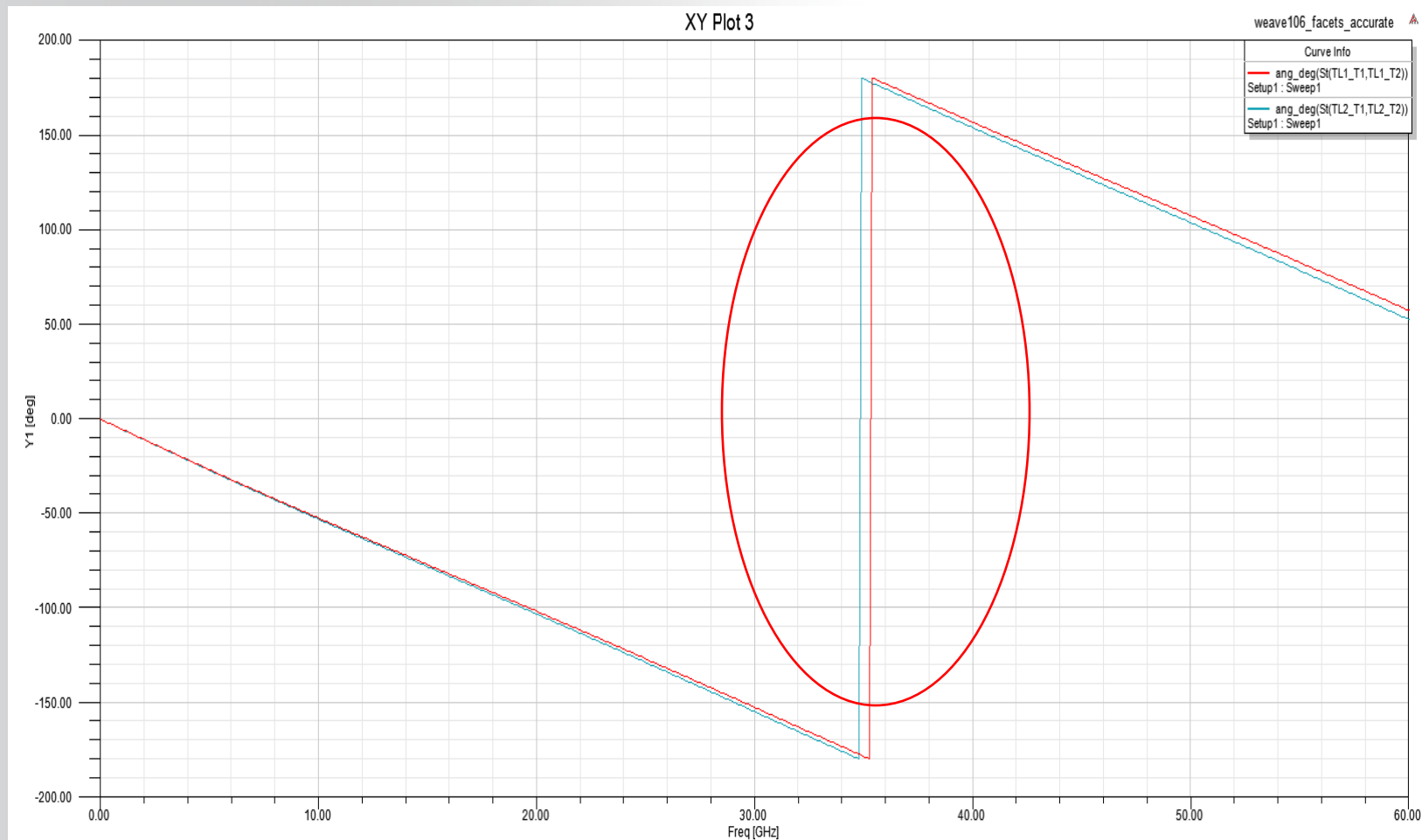
FR4 Fiber Weave



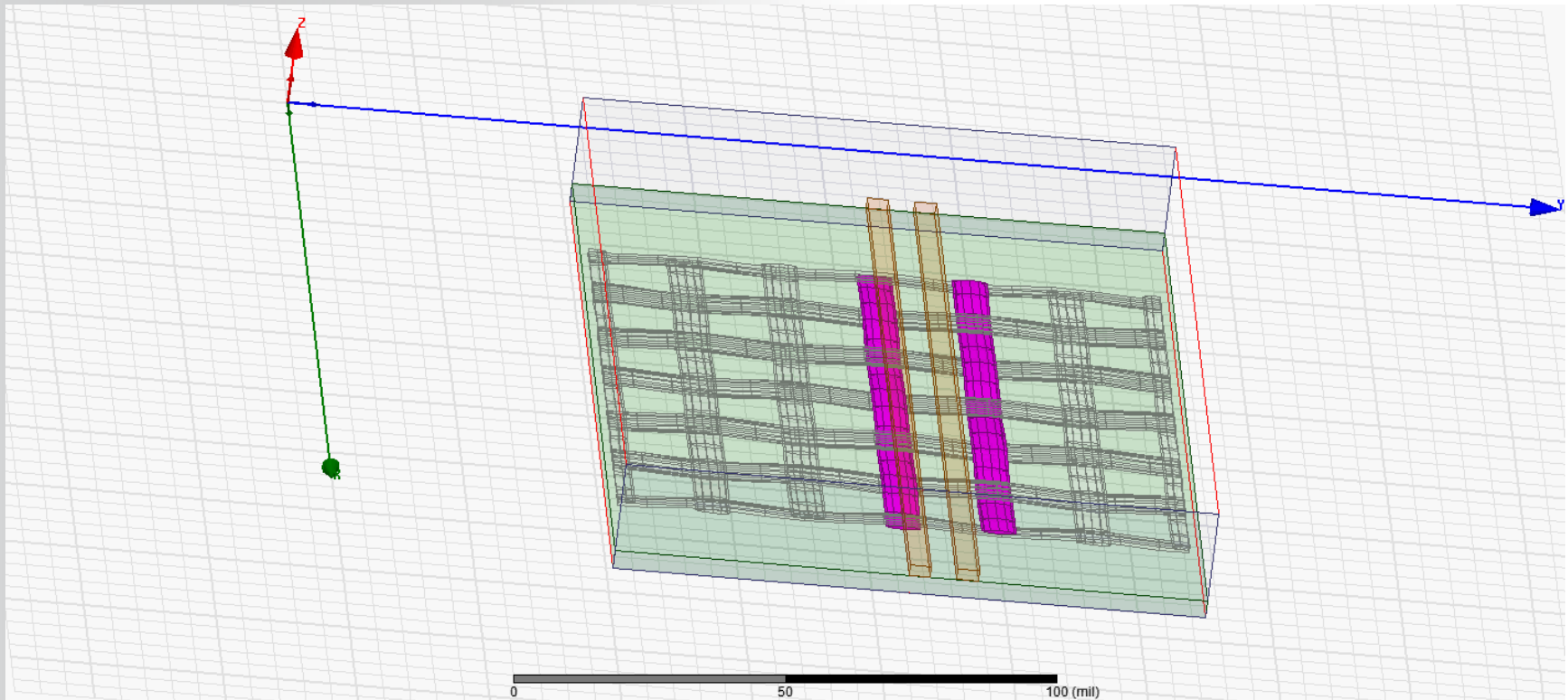
Insertion loss for one net



Differential skew Problem

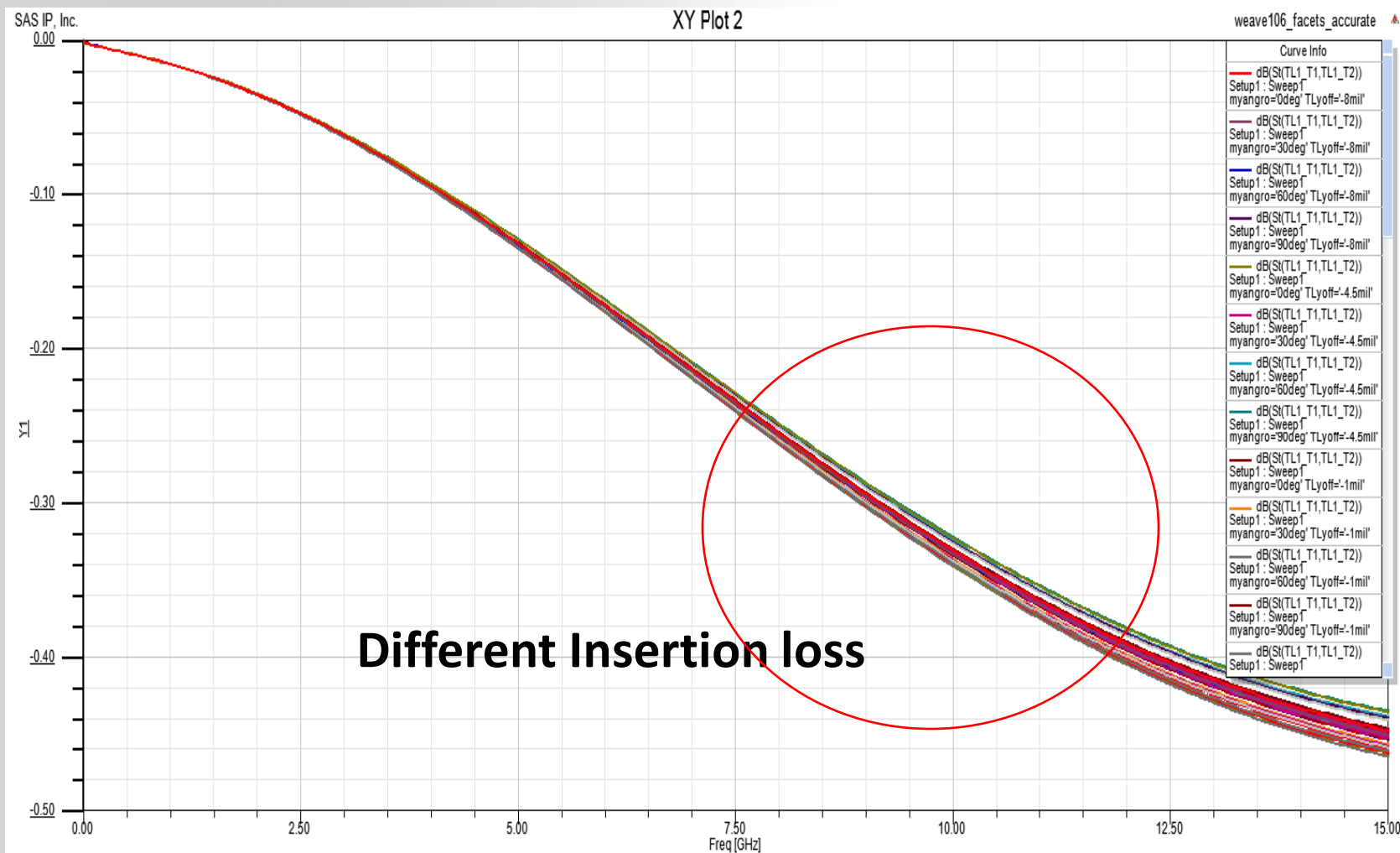


Anisotropic Substrates Variance

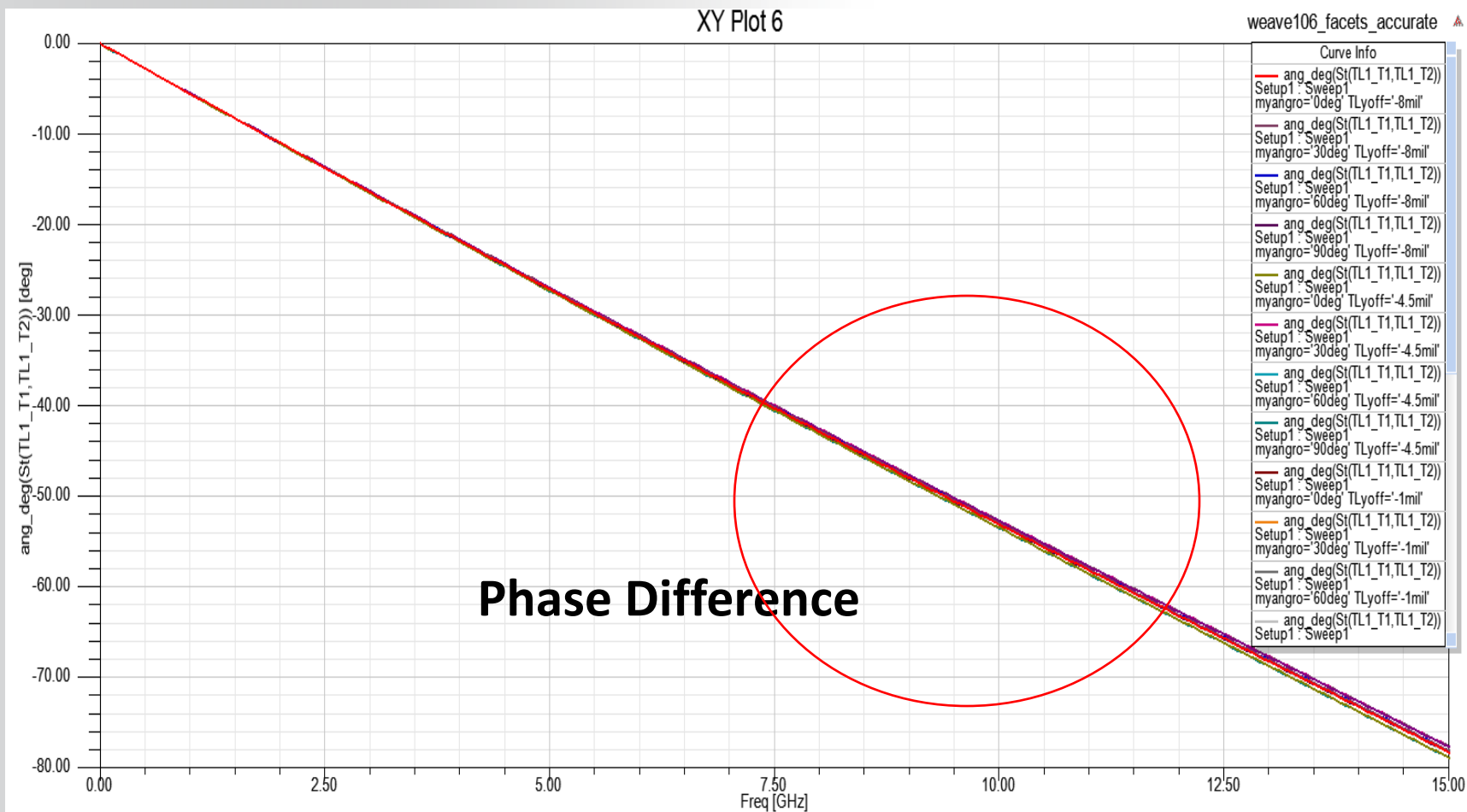


Change degree angle of rotation

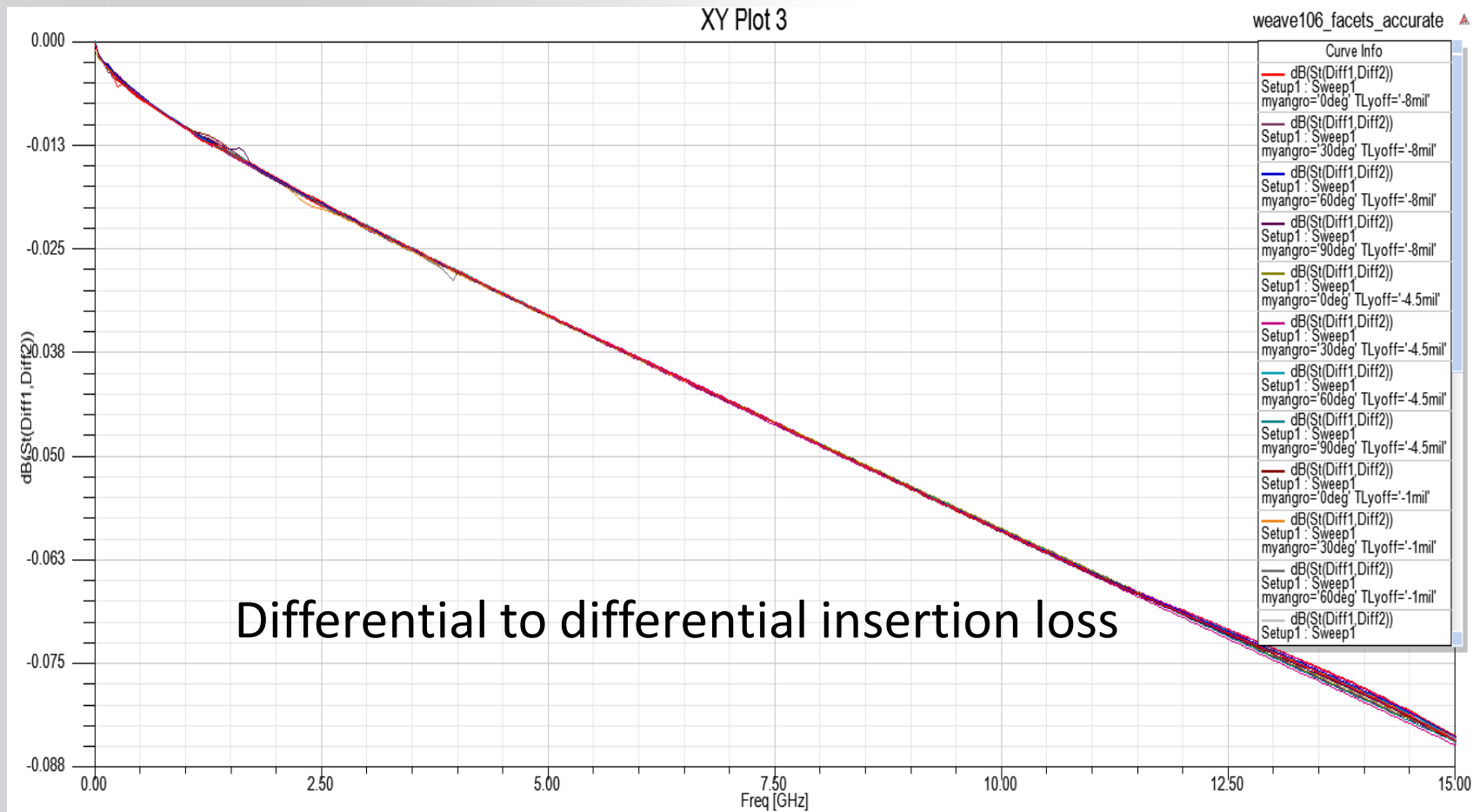
Anisotropic Substrates Variance



Anisotropic Substrates Variance



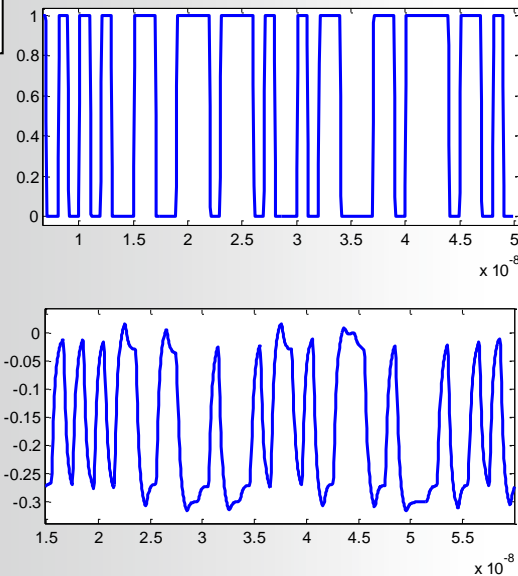
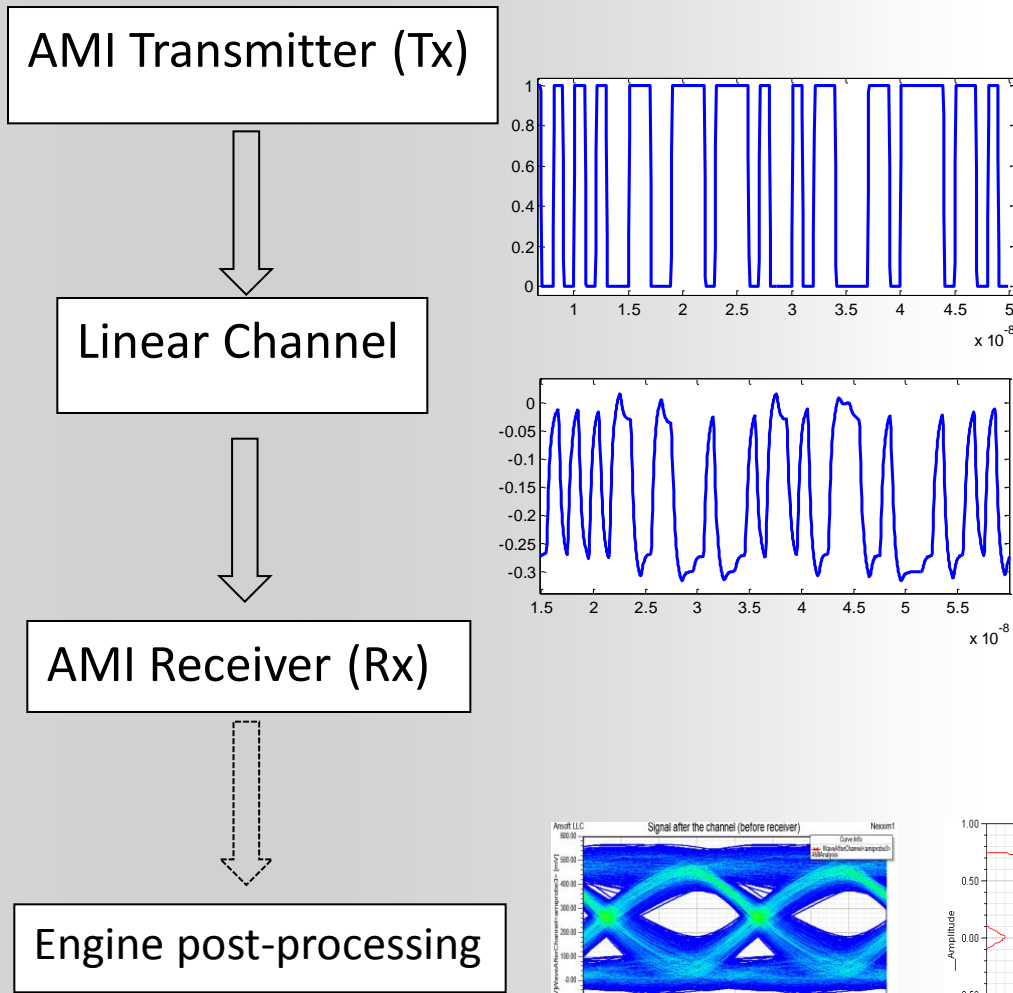
Anisotropic Substrates Variance





IBIS-AMI and statistical eye analysis

- **Use the final impulse response from AMI analysis to run statistical eye analysis**
- **Linear modifications (AMI Init) from Tx and Rx AMI models taken into account**
- **AMI GetWave functionality cannot be used for statistical analysis as it is a purely time domain function**



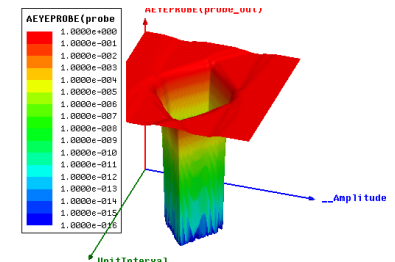
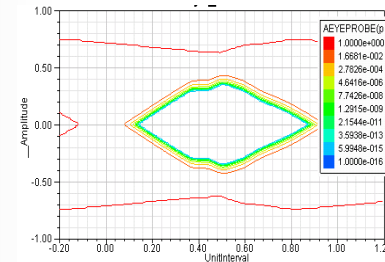
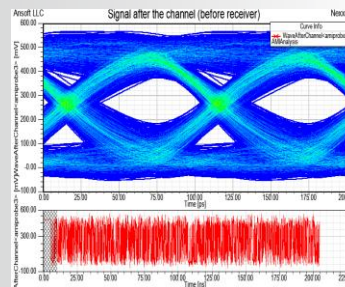
Very similar to Fast Convolution

- No backward dependency

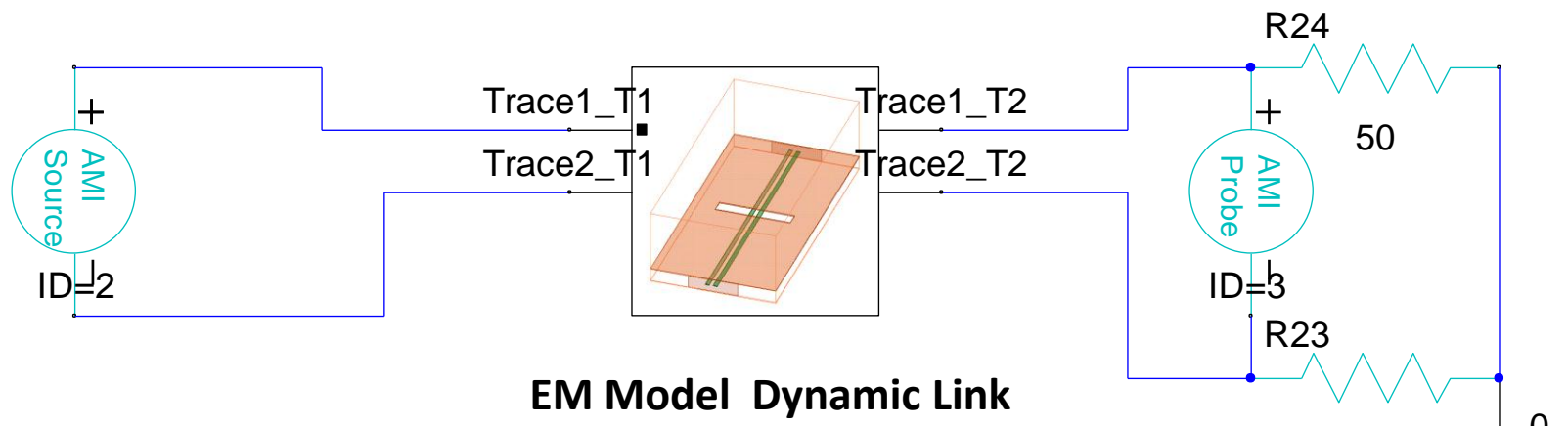
Transmitter and receiver are based on user supplied libraries.

Channel is characterized with impulse response function(s)

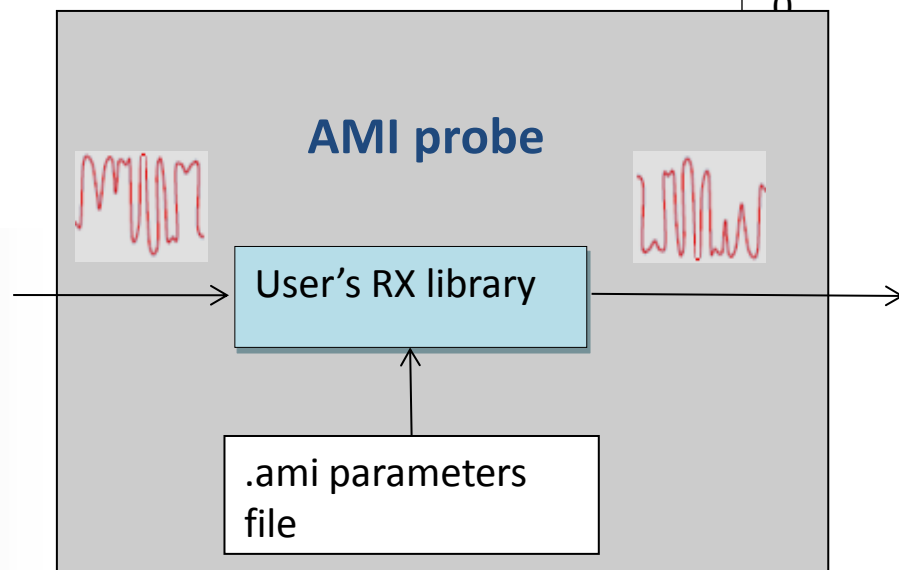
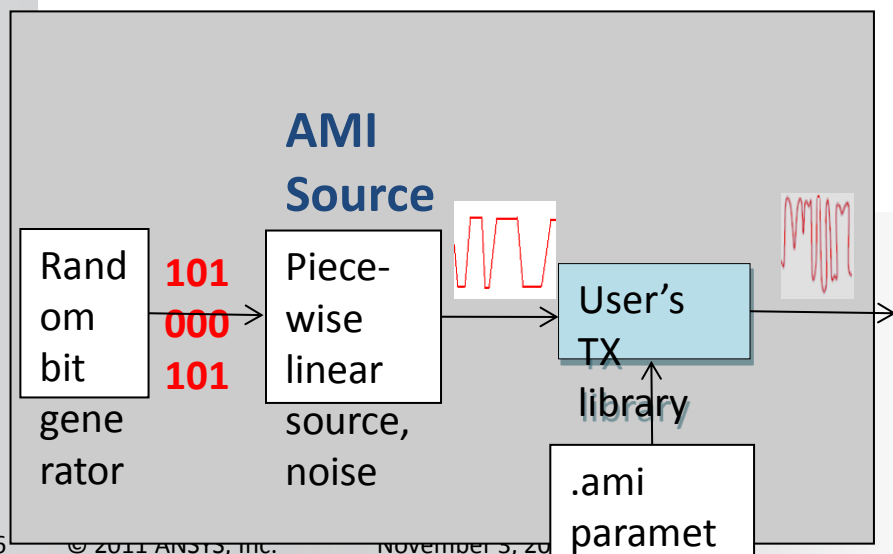
All signals are sampled with the constant time step and handled in blocks.



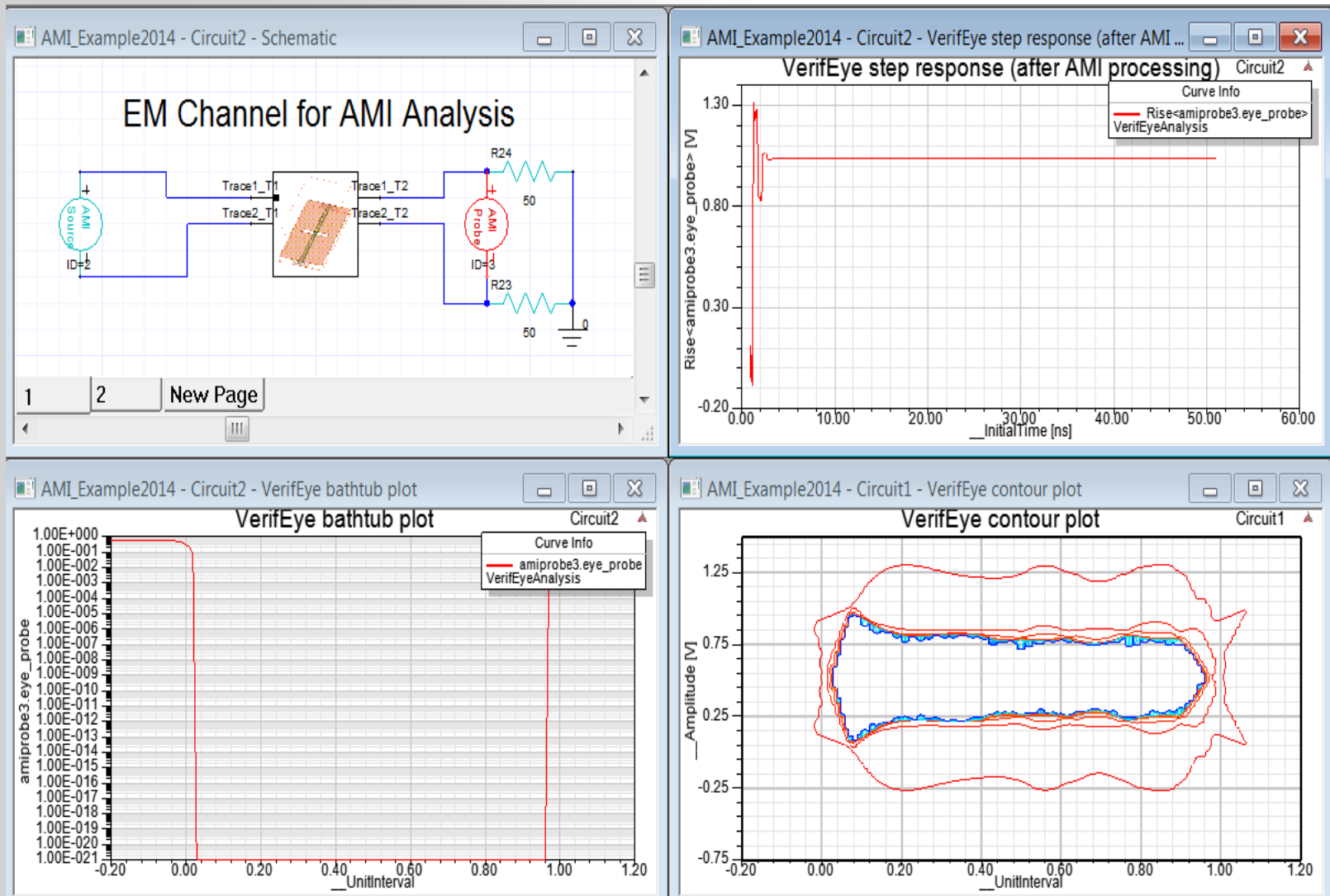
EM Channel for AMI Analysis



EM Model Dynamic Link

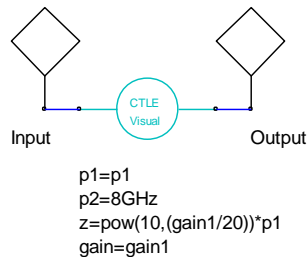


Statistical Eye Analysis Result



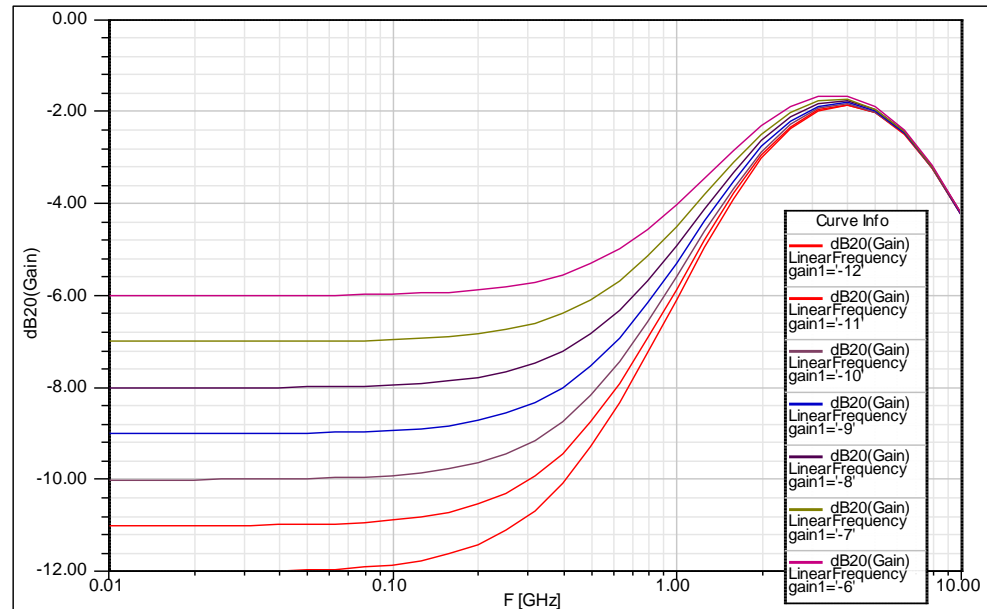
Circuit equalization techniques problem

CTLE Gain with PCIe3.0 Parameters



This example shows the response plot of a CTLE for PCIe 3.0 for different values of gain. Parameters of the CTLE component are:

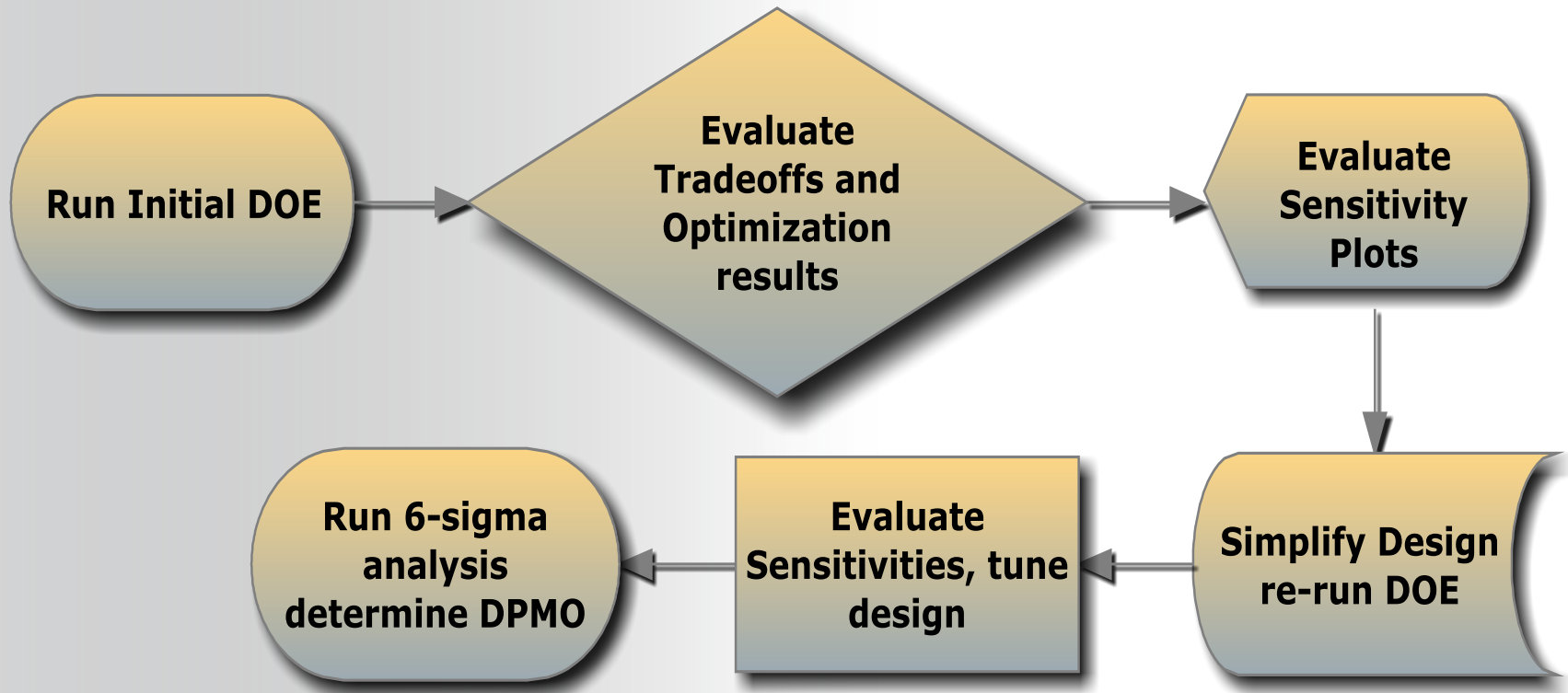
1. 'p1' LF Pole = 2 GHz
2. 'p2' HF Pole = 8 GHz
3. 'z' zero frequency = 'p1' * $\text{pow}(10, \text{'gain'}/20)$
4. 'gain' DC gain in dB = gain1



How to decide gain and pole value ??

How to do that?

- **Set up the DOE to sweep through the models to calculate the eye height and eye width for these cases**
- **The portions of the channel containing the PCB was modeled using a full-wave 3D electromagnetic extraction tool. A dynamic EM file was used to capture the channel's behavior. There are several variations of this structure that we want to include in the sensitivity analysis.**
- **To illustrate the results of this sensitivity analysis, we present sweeping of two of the variables: Change degree angle of rotation and equalization parameters**



EM Channel for AMI Analysis

The circuit diagram shows an AMI Source (ID=2) connected to a PCB model. The PCB model is connected to a network of traces (Trace1_T1, Trace1_T2, Trace2_T1, Trace2_T2) and a resistor (R24) with a value of 50. The circuit is connected to ground (0). The Design Setup dialog box is open, showing the Sim. Setup tab. The table below lists the input variables for the simulation.

Design Variable	Include	Override	Value	Units
rx_ffe1	<input checked="" type="checkbox"/>	<input type="checkbox"/>	1.2	
rx_ffe2	<input checked="" type="checkbox"/>	<input type="checkbox"/>	-0.1	
rx_ffe3	<input checked="" type="checkbox"/>	<input type="checkbox"/>	0.05	
tx_ffe1	<input checked="" type="checkbox"/>	<input type="checkbox"/>	1	
tx_ffe2	<input checked="" type="checkbox"/>	<input type="checkbox"/>	-0.2	
tx_ffe3	<input checked="" type="checkbox"/>	<input type="checkbox"/>	0.1	

Any parametric analysis

DOE - Workbench

File View Tools Units Help

New Open... Save Save As... Import... Preview Design of Experiments Update Design of Experiments Reconnect Refresh Project Update Project Resume Update All Design Points Project Compact Mode

Toolbox

- Analysis Systems
- Component Systems
- Custom Systems
- Design Exploration
- Goal Driven Optimization
- Parameters Correlation
- Response Surface
- Six Sigma Analysis

Project Schematic

A

- 1 External Connection
- 2 Designer
- 3 Parameters

Transient

Parameter Set

B

- 1 Goal Driven Optimization
- 2 Design of Experiments
- 3 Response Surface
- 4 Optimization

Goal Driven Optimization

C

- 1 Six Sigma Analysis
- 2 Design of Experiments (SSA)
- 3 Response Surface (SSA)
- 4 Six Sigma Analysis

Six Sigma Analysis

Properties of Schematic B2: Design of Experiments

A	B
Property	Value
General	
Cell ID	Design of Experiment
Design Points	
Preserve Design Points After DX Run	<input type="checkbox"/>
Design of Experiments	
Design of Experiments Type	Central Composite Design
Design Type	Auto Defined

What does It do?

- Design of Experiments (DOE)
- Response Surface Modeling
- Six Sigma Analysis
- Visual tools
 - Sensitivity Plots
 - Correlation Matrices
 - Parallel charts w Pareto Front display

Why Response Surface Modeling?

- Response Surface Modeling enables the designer to model and consider all aspects of a high speed channel design. Fit a statistical model to outputs of the design as a function of the change in input variables. A DOE table is used to select design points to solve explicitly for and the statistical model so to speak, “fills in the gaps”
- Optimized conditions and worst case scenarios are obtainable within the set of all possible design combinations within a realistic simulation timeframe.
- For example, this case, consider 8 variables or “factors”, if each variable has only 5 variations or “levels” we are looking at a huge number of possible combinations in order to find optimal solutions and or worst case scenarios.

$$\textit{Combinations} = \textit{Levels}^{\textit{Factors}} = 5^8!!!!$$

Speed Issue – HPC solution



- In this presentation, we can see the anisotropic substrates variance of PCBs, it effects phase difference between the differential pair
- Simulations on both EM dynamic models and IBIS-AMI models are applied to produce eye diagrams to check channel variance performance
- Circuit equalization techniques are applied at the Tx and Rx receiver to improve channel performance
- It is more efficient to get best channel performance by DOE and HPC solution